



Material Content Data Sheet



Sales Product Name		BTS71220-4ESE		Issued		4. July 2019		
MA#		MA005298562						
Package		PG-TSDSO-24-32		Weight*		112.81 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	2.514	2.23	2.23	22286	22286
leadframe	inorganic material	phosphorus	7723-14-0	0.016	0.01		142	
	non noble metal	zinc	7440-66-6	0.064	0.06		567	
	non noble metal	iron	7439-89-6	1.279	1.13		11336	
wire	non noble metal	copper	7440-50-8	51.928	46.03	47.23	460292	472337
	non noble metal	copper	7440-50-8	1.466	1.30	1.30	12993	12993
	encapsulation	organic material	carbon black	1333-86-4	0.152	0.13		1348
encapsulation	plastics	epoxy resin	-	5.931	5.26		52576	
	inorganic material	silicondioxide	60676-86-0	44.611	39.54	44.93	395441	449365
leadfinish	non noble metal	tin	7440-31-5	2.781	2.47	2.47	24653	24653
plating	noble metal	silver	7440-22-4	1.324	1.17	1.17	11732	11732
glue	plastics	epoxy resin	-	0.131	0.12		1161	
	noble metal	silver	7440-22-4	0.617	0.55	0.67	5473	6634
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com